Preferred Device

Silicon Controlled Rectifiers

Reverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls and power supplies; or wherever half-wave silicon gate-controlled, solid-state devices are needed.

- Glass Passivated Junctions with Center Gate Geometry for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Blocking Voltage to 800 Volts
- Device Marking: Logo, Device Type, e.g., 2N6400, Date Code

*MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off–State Voltage(1) (T _J = -40 to 125°C, Sine Wave 50 to 60 Hz; Gate Open) 2N6400 2N6401 2N6402 2N6403 2N6404 2N6405	VDRM, VRRM	50 100 200 400 600 800	Volts
On-State RMS Current (180° Conduction Angles; T _C = 100°C)	IT(RMS)	16	А
Average On-State Current (180° Conduction Angles; T _C = 100°C)	l _{T(AV)}	10	А
Peak Non-repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, T _J = 125°C)	ITSM	160	А
Circuit Fusing (t = 8.3 ms)	l ² t	145	A ² s
Forward Peak Gate Power (Pulse Width ≤ 1.0 μs, T _C = 100°C)	PGM	20	Watts
Forward Average Gate Power (t = 8.3 ms, T _C = 100°C)	PG(AV)	0.5	Watts
Forward Peak Gate Current (Pulse Width \leq 1.0 μ s, T _C = 100°C)	I _{GM}	2.0	А
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

^{*}Indicates JEDEC Registered Data.

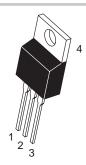


ON Semiconductor

http://onsemi.com

SCRs 16 AMPERES RMS 50 thru 800 VOLTS





TO-220AB CASE 221A STYLE 3

PIN ASSIGNMENT				
1	Cathode			
2	Anode			
3	Gate			
4	Anode			

ORDERING INFORMATION

Device	Package	Shipping
2N6400	TO220AB	500/Box
2N6401	TO220AB	500/Box
2N6402	TO220AB	500/Box
2N6403	TO220AB	500/Box
2N6404	TO220AB	500/Box
2N6405	TO220AB	500/Box

Preferred devices are recommended choices for future use and best overall value.

⁽¹⁾ VDRM and VRRM for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

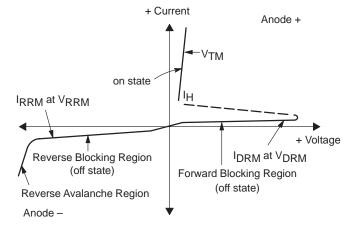
ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						•
*Peak Repetitive Forward or Reverse Blocking Control (VAK = Rated VDRM or VRRM, Gate Open)	urrent T _J = 25°C T _J = 125°C	IDRM, IRRM	_	_	10 2.0	μA mA
ON CHARACTERISTICS						
*Peak Forward On–State Voltage (I _{TM} = 32 A Peak, Pulse Width ≤ 1 ms, Duty Cy	/cle ≤ 2%)	V _{TM}	_	_	1.7	Volts
*Gate Trigger Current (Continuous dc) (V _D = 12 Vdc, R _L = 100 Ohms)	$T_C = 25^{\circ}C$ $T_C = -40^{\circ}C$	lGT	_ _	9.0 —	30 60	mA
*Gate Trigger Voltage (Continuous dc) (V _D = 12 Vdc, R _L = 100 Ohms)	T _C = 25°C T _C = -40°C	VGT	_	0.7 —	1.5 2.5	Volts
Gate Non-Trigger Voltage (V _D = 12 Vdc, R _L = 100 Ohms)	T _C = +125°C	V _{GD}	0.2	_	_	Volts
*Holding Current (V _D = 12 Vdc, Initiating Current = 200 mA, Gate Open)	$T_C = 25^{\circ}C$ $*T_C = -40^{\circ}C$	Ιн	_	18 —	40 60	mA
Turn-On Time $(I_{TM} = 16 \text{ A}, I_{GT} = 40 \text{ mAdc}, V_D = \text{Rated V}_{DR})$	M)	^t gt	_	1.0	_	μs
Turn-Off Time (I _{TM} = 16 A, I _R = 16 A, V _D = Rated V _{DRM})	T _C = 25°C T _J = +125°C	^t q	_	15 35		μs
DYNAMIC CHARACTERISTICS						
Critical Rate-of-Rise of Off-State Voltage (VD = Rated VDRM, Exponential Waveform)	T _J = +125°C	dv/dt	_	50	_	V/µs

^{*}Indicates JEDEC Registered Data.

Voltage Current Characteristic of SCR

Symbol	Parameter
VDRM	Peak Repetitive Off State Forward Voltage
IDRM	Peak Forward Blocking Current
VRRM	Peak Repetitive Off State Reverse Voltage
IRRM	Peak Reverse Blocking Current
V_{TM}	Peak On State Voltage
lμ	Holding Current



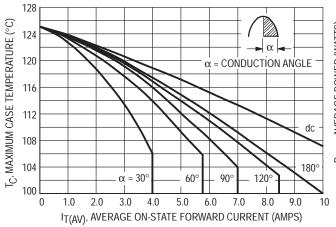


Figure 1. Average Current Derating

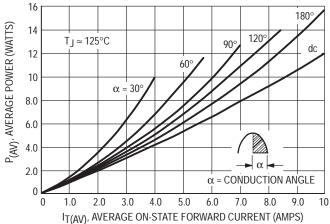


Figure 2. Maximum On-State Power Dissipation

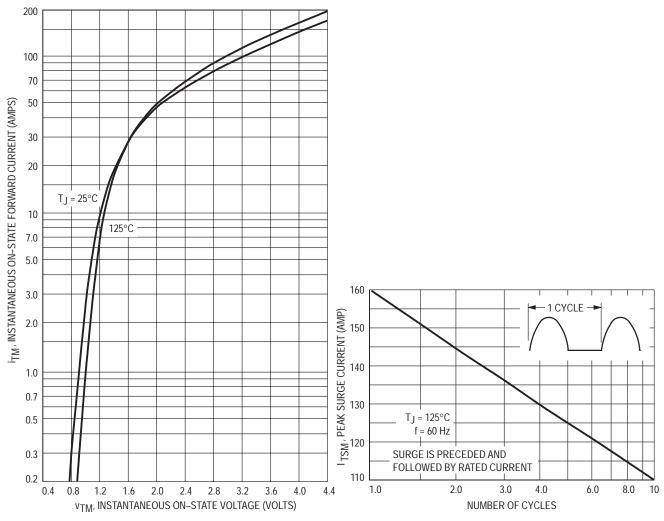


Figure 3. On-State Characteristics

Figure 4. Maximum Non-Repetitive Surge Current

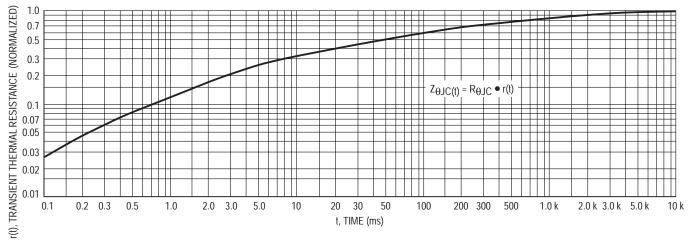


Figure 5. Thermal Response

TYPICAL CHARACTERISTICS

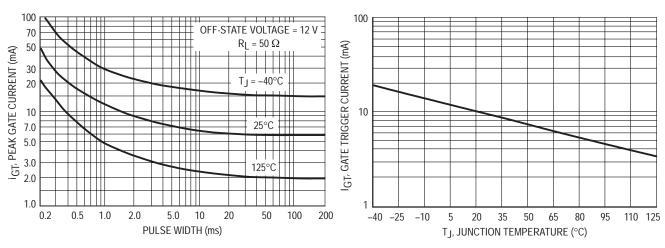


Figure 6. Typical Gate Trigger Current versus Pulse Width

Figure 7. Typical Gate Trigger Current versus Junction Temperature

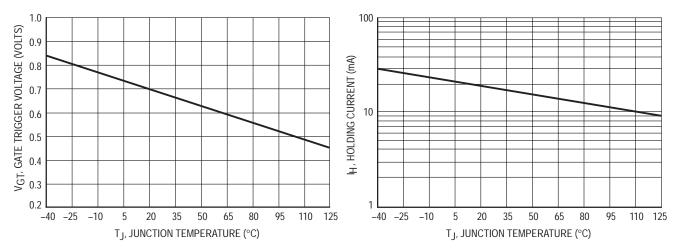
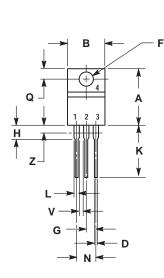


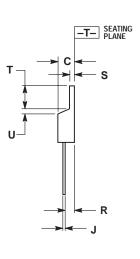
Figure 8. Typical Gate Trigger Voltage versus Junction Temperature

Figure 9. Typical Holding Current versus Junction Temperature

PACKAGE DIMENSIONS

TO-220AB CASE 221A-07 ISSUE Z





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

- STYLE 3:
 PIN 1. CATHODE
 2. ANODE
 3. GATE
 4. ANODE



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